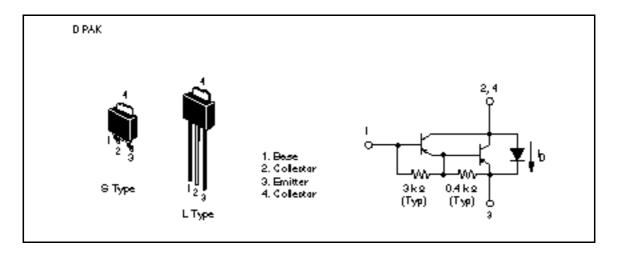
Silicon PNP Triple Diffused

HITACHI

Application

Medium speed power amplifier

Outline





Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

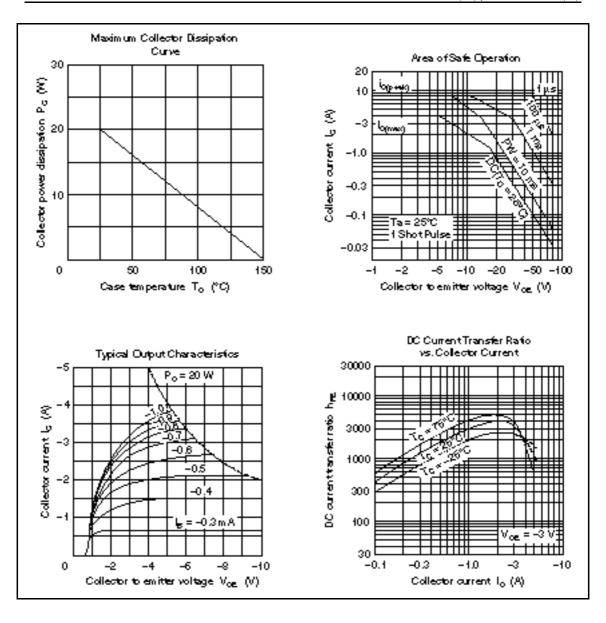
Item	Symbol	Rating	Unit
Collector to base voltage	V_{CBO}	-100	V
Collector to emitter voltage	V_{CEO}	-80	V
Emitter to base voltage	V_{EBO}	- 7	V
Collector current	I _c	-4	А
C to E diode forward current	I _D *1	4	А
Collector peak current	I _{C(peak)}	-8	А
Collector power dissipation	Pc*1	20	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

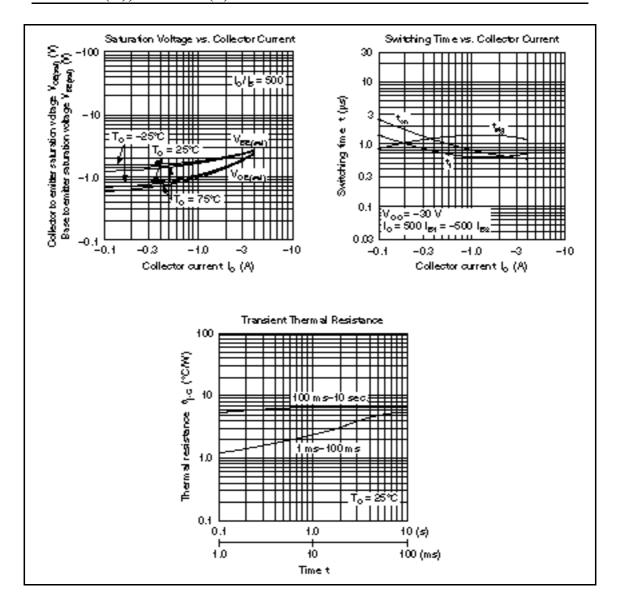
Note: 1. Value at $T_c = 25^{\circ}C$

Electrical Characteristics ($Ta = 25^{\circ}C$)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-80	_	_	V	$I_{\rm C}$ = -25 mA, $R_{\rm BE}$ =
Emitter to base breakdown voltage	$V_{(BR)EBO}$	- 7	_	_	V	$I_{\rm E} = -50 \text{ mA}, I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	_	-100	μΑ	$V_{CB} = -80 \text{ V}, I_{E} = 0$
	I _{CEO}	_	_	-10	μΑ	$V_{CE} = -60 \text{ V}, R_{BE} =$
DC current transfer ratio	h _{FE}	1000	_	20000		$V_{CE} = -3 \text{ V}, I_{C} = -2 \text{ A}^{*1}$
Collector to emitter saturation	$V_{\text{CE(sat)1}}$	_	_	-1.5	V	$I_{\rm C} = -2 \text{ A}, I_{\rm B} = -4 \text{ mA}^{*1}$
voltage	$V_{\text{CE(sat)2}}$	_	_	-3.0	V	$I_{\rm C} = -4 \text{ A}, I_{\rm B} = -40 \text{ mA}^{*1}$
Base to emitter saturation	$V_{\text{BE(sat)1}}$	_	_	-2.0	V	$I_{\rm C} = -2 \text{ A}, I_{\rm B} = -4 \text{ mA}^{*1}$
voltage	$V_{BE(sat)2}$	_	_	-3.5	V	$I_{\rm C} = -4 \text{ A}, I_{\rm B} = -40 \text{ mA}^{*1}$
C to E diode forward voltage	$V_{\scriptscriptstyle D}$	_	_	3.0	V	$I_{D} = 4 A^{*1}$
Turn on time	\mathbf{t}_{on}	_	0.5	_	μs	$I_{\rm C} = -2 \text{ A}, I_{\rm B1} = -I_{\rm B2} = -4 \text{ mA}$
Storage time	t _{stg}	_	1.5	_	μs	_
Fall time	t _f	_	1.0	_	μs	

Note: 1. Pulse test.





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